

**RECEIVED**  
**CENTRAL FAX CENTER**

MAY 21 2007

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/511,792      Confirmation No.: 6292  
Applicant(s): Radenne et al.  
Filed: 5/9/2005  
Art Unit: 2815  
Examiner: Chu, Chris C.  
Title: Method For Encapsulation Of A Chipcard And Module  
Obtained Thus

Attorney Docket No.: 003D.0032.U1(US)  
Customer No.: 29,683

Commissioner For Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Amendment

Sir:

This is in response to the Office Action mailed 03/27/2007 in regard to the above-identified patent application. Please amend the Application as indicated on the following pages.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begin on page 3 of this paper.

Amendments to the Drawings begin on page 8 and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks begin on page 9 of this paper.

An Appendix including amended drawing figures is attached following page 15 of this paper.